



Product Change Notification

111575 - 00

Information in this document is provided in connection with Intel® products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2012. Other names and brands may be claimed as the property of others.

BunnyPeople, Celeron, Celeron Inside, Centrino, Centrino Inside, Cilk, Core Inside, i960, Intel, the Intel logo, Intel AppUp, Intel Atom, Intel Atom Inside, Intel Core, Intel Inside, Intel Insider, the Intel Inside logo, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel Sponsors of Tomorrow, the Intel Sponsors of Tomorrow logo, Intel StrataFlash, Intel vPro, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Itanium, Itanium Inside, MCS, MMX, Moblin, Pentium, Pentium Inside, Puma, skool, the skool logo, Sound Mark, The Creators Project, The Journey Inside, Thunderbolt, vPro Inside, VTune, Xeon, and Xeon Inside are trademarks of Intel Corporation in the U.S. and/or other countries.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.



Product Change Notification

Change Notification #: 111575 - 00
Change Title: Intel® HM55 & QM57 Express Chipsets, PCN 111575-00, Product Support, Transitioning from Intel Architecture to Embedded Architecture
Date of Publication: July 02, 2012

Key Characteristics of the Change:

Product Support

Forecasted Key Milestones:

Last Demand Due Date to Local Intel Representative Prior to Product Support Change:	Oct 05, 2012
Last Discontinuance Assurance Prior to Product Support Change:	Nov 09, 2012
Last Corporate Assurance Product Critical Date Prior to Product Support Change:	Jan 17, 2013
Last Order Date Prior to Product Support Change:	Jan 25, 2013
Orders are Non-Cancelable and Non-Returnable After:	Jan 25, 2013
Last Shipment Date Prior to Product Support Change:	Mar 22, 2013

Description of Change to the Customer:

No change for Embedded Intel Architecture customers.

Intel® support for the products listed in the "Products Affected/Intel Ordering Codes" table below is moving to the Embedded and Communications Group for the continued support of Embedded Intel® Architecture customers. The Embedded Intel® Architecture terms, conditions, and pricing will go into effect for all customers after the "Last Shipment Date Prior to Product Support Change" listed above. Please contact your Embedded Intel® Architecture sales representative if you have any questions regarding this change.

Customer Impact of Change and Recommended Action:

There is no expected impact to Embedded Intel Architecture customers.

The product transfer will be transparent with notification via a Product Support Notification to customers. Customers may experience longer through put times from the warehouse, as products will be coming off of forward stage. These Chipset products will stay on the Intel Customer Planning Re-engineering (CPR) post transfer. Prior to transfer customers will need to be prepared to ship from WLOC.

For Intel Architecture customers please determine your remaining demand prior to the product support change and place your last orders in accordance with the "Key Milestones" listed above. "Last Discontinuance Assurance Prior to Product Support Change:" is the date that customers must submit a sales order or Memorandum of Understanding (MOU) to hold the discontinued product assurance they have requested. The products listed on the "Products Affected/Intel Ordering Codes" table below will remain on Intel's Corporate Assurance Process until the "Last Order Date Prior to Product Support Change."

Once product support is officially transferred to the Embedded Intel Architecture Communications Group, all discounts approved prior to "Last Shipment Date Prior to Product Support change" will no longer be honored.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	Stepping	MM#
Intel® BD82QM57 Platform Controller Hub	BD82QM57	S LGZQ	B3	904125
Intel® BD82HM55 Platform Controller Hub	BD82HM55	S LGZS	B3	904127

PCN Revision History:

Date of Revision:

Jul 02, 2012

Revision Number:

00

Reason:

Originally Published PCN